

NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V <sub>CC</sub>	50V
I <sub>C(MAX.)</sub>	100mA
R <sub>1</sub>	2.2kΩ
R <sub>2</sub>	10kΩ

## Features

1) Built-In Biasing Resistors,

 $R_1 = 2.2k\Omega, R_2 = 10k\Omega$ 

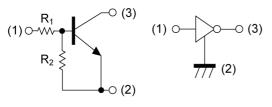
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA123Y series

## Application

INVERTER, INTERFACE, DRIVER

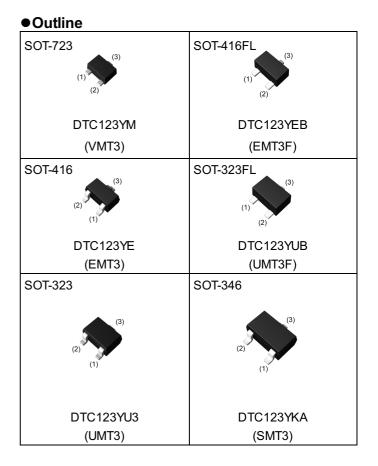
#### Inner circuit

DTC123YM/ DTC123YEB/ DTC123YUB

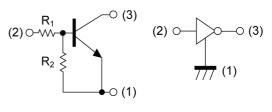


(1) IN (BASE)(2) GND (EMITTER)(3) OUT (COLLECTOR)

#### Packaging specifications



# DTC123YE/ DTC123YU3/ DTC123YKA



(1) GND (EMITTER)
(2) IN (BASE)
(3) OUT (COLLECTOR)

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC123YM	SOT-723	1212	T2L	180	8	8000	62
DTC123YEB	SOT-416FL	1616	TL	180	8	3000	62
DTC123YE	SOT-416	1616	TL	180	8	3000	62
DTC123YUB	SOT-323FL	2021	TL	180	8	3000	62
DTC123YU3	SOT-323	2021	T106	180	8	3000	62
DTC123YKA	SOT-346	2928	T146	180	8	3000	62

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

F	Parameter	Symbol	Values	Unit
Supply voltage	V <sub>CC</sub>	50	V	
Input voltage		V <sub>IN</sub>	-5 to 12	V
Output current		Ι <sub>Ο</sub>	100	mA
Collector current	I <sub>C(MAX)</sub> *1	100	mA	
	DTC123YM		150	
	DTC123YEB		150	
Dewer discipation	DTC123YE	P*2	150	
Power dissipation	DTC123YUB		200	— mW
	DTC123YU3		200	
	DTC123YKA		200	
Junction temperature		Tj	150	°C
Range of storage tempera	ature	T <sub>stg</sub>	-55 to +150	°C

## •Electrical characteristics (T<sub>a</sub> = 25°C)

Demonster	Ourseland	Quaditions	Values			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
	V <sub>I(off)</sub>	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100µA	-	-	0.3	N
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = 0.3V, I <sub>O</sub> = 20mA	3.0	-	-	V
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 10mA, I <sub>I</sub> = 0.5mA	-	100	300	mV
Input current	I <sub>I</sub>	V <sub>1</sub> = 5V	-	-	3.8	mA
Output current	I <sub>O(off)</sub>	$V_{CC} = 50V, V_{I} = 0V$	-	-	500	nA
DC current gain	G	V <sub>O</sub> = 5V, I <sub>O</sub> = 10mA	33	-	-	-
Input resistance	R <sub>1</sub>	-	1.54	2.2	2.86	kΩ
Resistance ratio	$R_2/R_1$	-	3.6	4.5	5.5	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz

\*1 Characteristics of built-in transistor

\*2 Each terminal mounted on a reference land.



100

100

80

60

40

20

0

0

OUTPUT CURRENT : Io [mA]

Ta=25℃

Pulsed

# •Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)



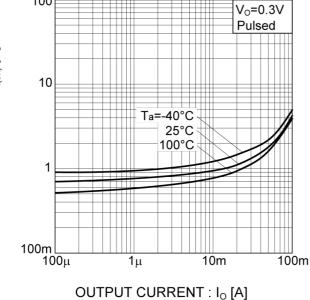


Fig.3 Output current vs. output voltage

Fig.2 Output current vs. input voltage (OFF characteristics)

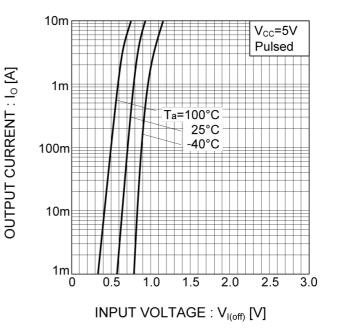
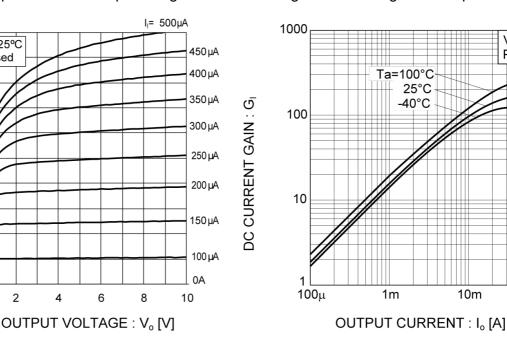


Fig.4 DC current gain vs. output current



2

4

6

3/10

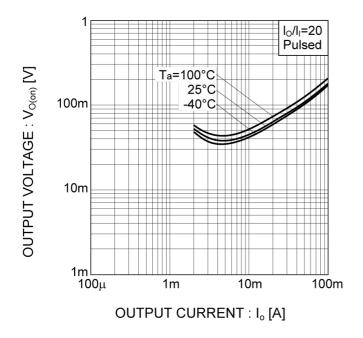


Vo=5V

Pulsed

100m

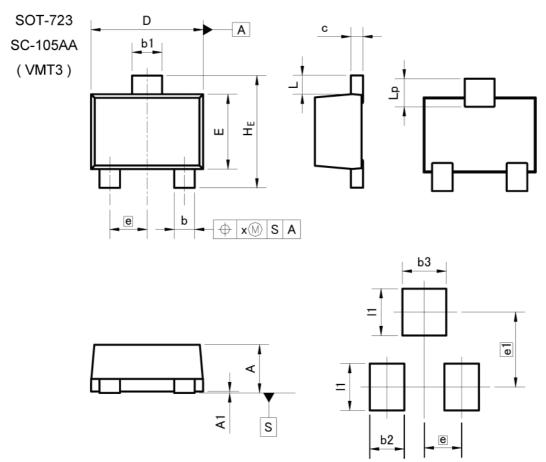
# •Electrical characteristic curves (T<sub>a</sub> =25°C)



## Fig.5 Output voltage vs. output current



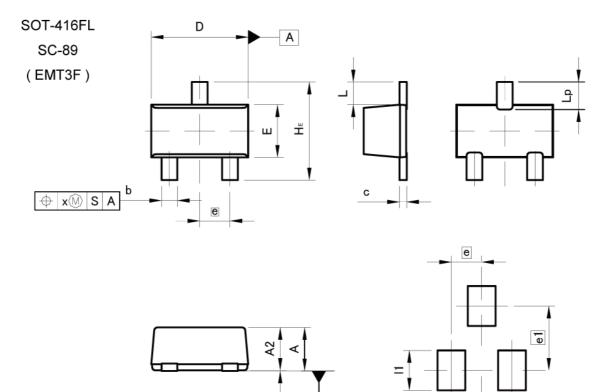




Pattern of terminal position areas [Not a pattern of soldering pads]

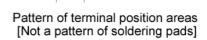
DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
с	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
x	-	0.10	-	0.004
DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	-	0.015
b3	-	0.47		0.019
e1	0.80		0.031	
11		0.50		0.020





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b2

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
с	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.5	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.015	
Lp	0.35	0.55	0.014	0.022
x	—	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.46	-	0.018
e1	—	1.05		0.041
- 11	-	0.65	-	0.026

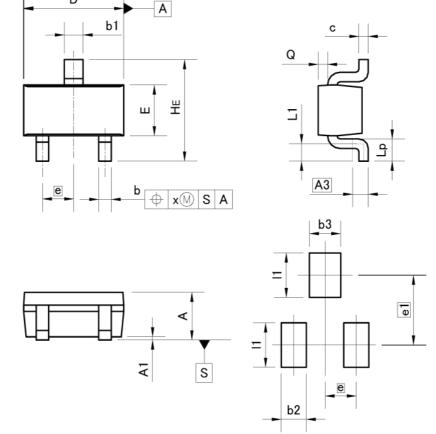






D

## (EMT3)



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15	-	0.006	2.7
Q	0.05	0.25	0.002	0.010
х	-	0.10	-	0.004

DIM		ETERS	INC	HES
	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	-	0.50	-	0.020
e1	1.10		0.0	43
1	s.—	0.70		0.028





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
с	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L	0.4	25	0.0	17
Lp	0.43	0.63	0.017	0.025
x	-	0.10	-	0.004
DIM	MILIM	ETERS	INCHES	
DIM				

DIM	MILIM	ETERS	INCHES	
DIN	MIN	MAX	MIN	MAX
b2	-	0.52	-	0.020
e1	1.47		0.0	58
11	- 0.83		-	0.033

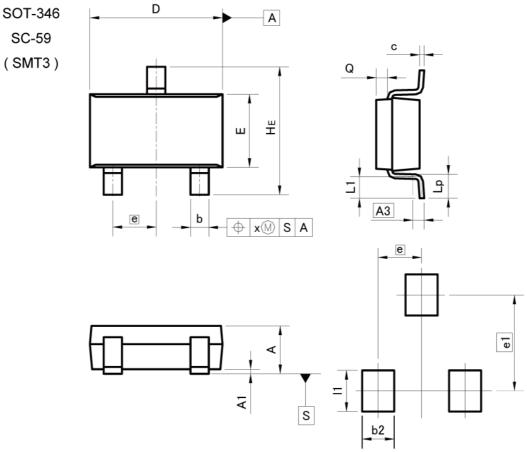




Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.0	10
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
x	-	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	_	0.50	-	0.020
e1	1.55		0.061	
1	-	0.65	-	0.026





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
А	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.1	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.9	95	0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х		0.10	-	0.004
У	-	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES

DIM	MILIMETERS		INCHES	
DIN	MIN	MAX	MIN	MAX
b2	-	0.60	-	0.024
e1	2.10		0.083	
1	-	0.90	-	0.035



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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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